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DATE MAILED: 03/15/2005

APPLICATION NO	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/642,609	10/642,609 08/19/2003		Cheng-Hsien Chou	CHOU3087/EM	2818
23364	7590	03/15/2005	EXAMINER		
BACON &		•	NGUYEN, DILINH P		
FOURTH I			ART UNIT	PAPER NUMBER	
ALEXAND	DRIA, VA	22314	2814		

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)						
	10/642,609	CHOU ET AL.						
Office Action Summary	Examiner	Art Unit						
	DiLinh Nguyen	2814						
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply								
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).								
Status								
1) Responsive to communication(s) filed on 19 Au	igust 2003.							
2a) ☐ This action is <b>FINAL</b> . 2b) ☑ This	action is non-final.							
3) ☐ Since this application is in condition for allowan	-							
closed in accordance with the practice under E.	x parte Quayle, 1935 C.D. 11, 45	3 O.G. 213.						
Disposition of Claims								
4) Claim(s) 1-5 is/are pending in the application.	Claim(s) <u>1-5</u> is/are pending in the application.							
	4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.	Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-5</u> is/are rejected.								
7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or	election requirement							
8) Claim(s) are subject to restriction and/or	election requirement.	,						
Application Papers								
9) The specification is objected to by the Examiner.								
	0)  The drawing(s) filed on is/are: a)  accepted or b)  objected to by the Examiner.							
• • • • • • • • • • • • • • • • • • • •	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).  11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.								
11) Ine oath or declaration is objected to by the Ex	anniner. Note the attached Office	Action of form P 10-132.						
Priority under 35 U.S.C. § 119								
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.								
2. Certified copies of the priority documents have been received in Application No								
3. Copies of the certified copies of the priority documents have been received in this National Stage								
application from the International Bureau (PCT Rule 17.2(a)).								
* See the attached detailed Office action for a list of the certified copies not received.								
A44 - b								
Attachment(s)  1) Notice of References Cited (PTO-892)  4) Interview Summary (PTO-413)								
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  Paper No(s)/Mail Date								
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	6) Other:	atent Application (FTO-102)						

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#### **DETAILED ACTION**

### Claim Objections

Claims 1-5 are objected to because of the following informalities:

Line 3, claim 1, replace "a printed circuit board" with -the printed circuit board--.

Line 1, claims 2-5, replace "a printed circuit board" with -the printed circuit board-

Line 2, claim 2, replace "the central spacings" with -a central spacings-

Line 2, claim 3, replace "the width" with –a width—

Line 2, claim 4, replace "the thickness" with -a thickness-

Line 2, claim 5, replace "the primary material" with -a primary material--.

Appropriate correction is required.

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-5 are rejected under 35 U.S.C. 103(a) as being unpatentable over AAPA (fig. 5) in view of Zohar et al. (U.S. Pat. 6754551).

AAPA (fig. 5) disclose a method for applying solder mask 30 onto solder pad spacings on a printed circuit board 20; a plurality of solder pads 22; a clearance d2 between the solder mask 30 and the solder pads 22.

AAPA fail to disclose an ink-jet printer is employed to print solder mask onto solder pad spacings.

However, Zohar et al. disclose an ink-et printer 204 is employed to print solder mask 205 on a printed circuit board (cover fig., column 31, lines 58-61). Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to apply an ink-jet printer for printing the solder mask onto solder pad spacing on the PCB, as taught by Zohar et al., into the process of AAPA in order to achieve at desired registration precision level the dispensing of solder mask onto the surface of PCB (abstract).

- Regarding claim 2, AAPA discloses that a central spacings of the solder pads 22 are smaller than or equal to 0.5 mm (fig. 5, page 1, lines 30-31).
- Regarding claim 3, AAPA disclose that a width of the solder mask is no wider than 150 μm (fig. 5).
- Regarding claim 4, AAPA disclose that a thickness of the solder mask 30 is equal
   a thickness of the solder pads 22 (figs. 5-6) and it is obvious to control the
   thickness of the solder mask is no thicker than 55 μm.
- Regarding claim 5, Zohar et al. disclose a primary material for the solder mask can be epoxy resin series or acrylic resin series (column 23, lines 23-25).

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DiLinh Nguyen whose telephone number is (571) 272-1712. The examiner can normally be reached on 8:00AM - 6:00PM (M-F).

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

DLN

HOAI PHAM
PRIMARY EXAMINER